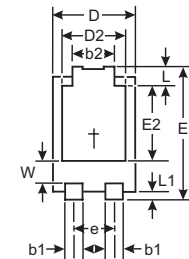
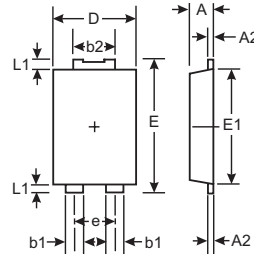


**Features**

- Glass Passivated Die Construction
- Low Leakage Current
- **Lead Free Finish, RoHS Compliant (Note 1)**
- "Green" Molding Compound (No Br, Sb)
- **Qualified to AEC-Q101 Standards for High Reliability**

**Mechanical Data**

- Case: PowerDI™5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: See Diagram
- Marking: See Page 3
- Weight: 0.096 grams (approximate)



Note: Pins Left & Right must be electrically connected at the printed circuit board.

PowerDI™5		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.05 NOM	
E	6.40	6.60
e	1.84 NOM	
E1	5.30	5.45
E2	3.55 NOM	
L	0.75	0.95
L1	0.50	0.65
W	1.20	1.50
<b>All Dimensions in mm</b>		

**Maximum Ratings** @ T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	400	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	283	V
Average Rectified Output Current (See also figure 4)	I <sub>O</sub>	5	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I <sub>FSM</sub>	100	A
Operating Temperature Range	T <sub>j</sub>	-65 to +150	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to +150	°C

**Thermal Characteristics** @ T<sub>A</sub> = 25°C unless otherwise specified

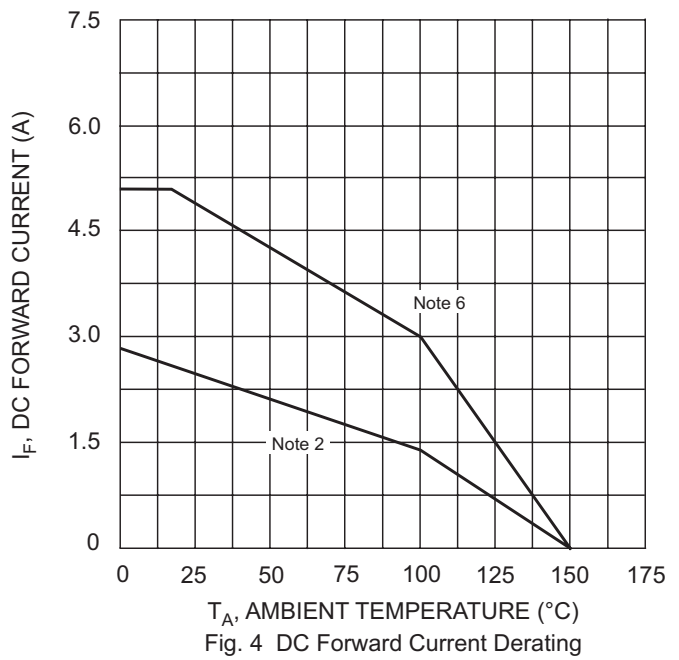
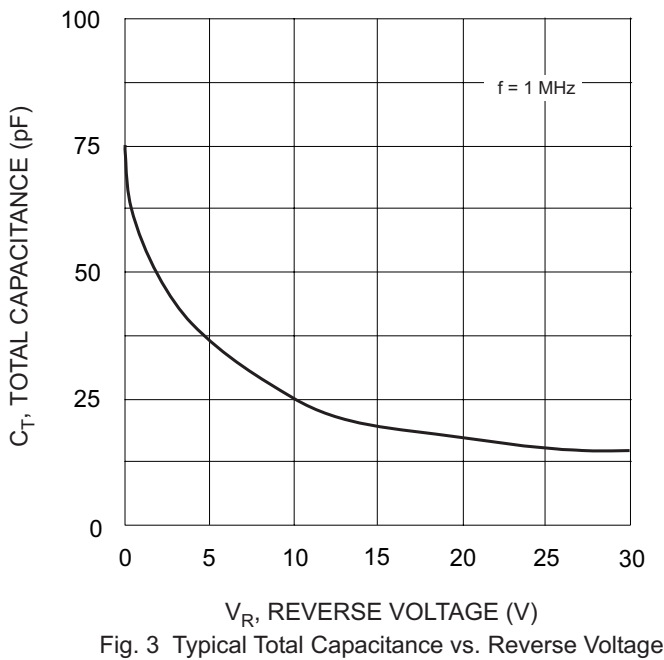
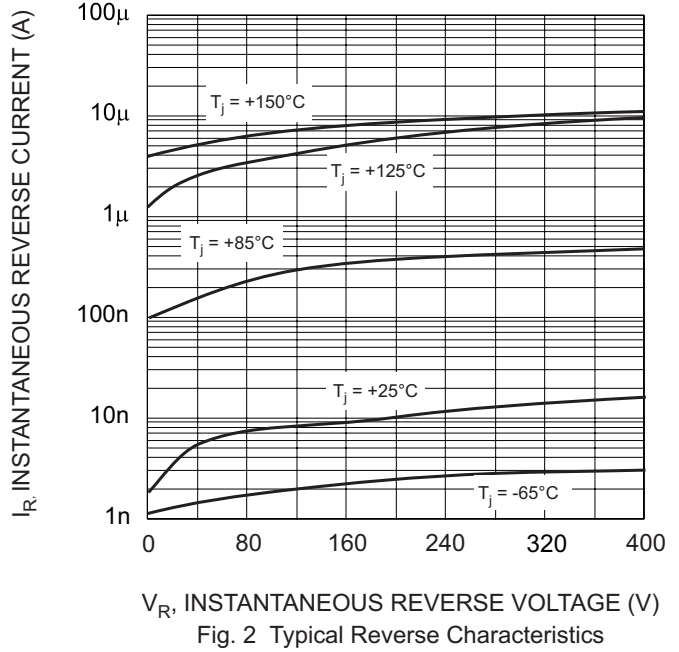
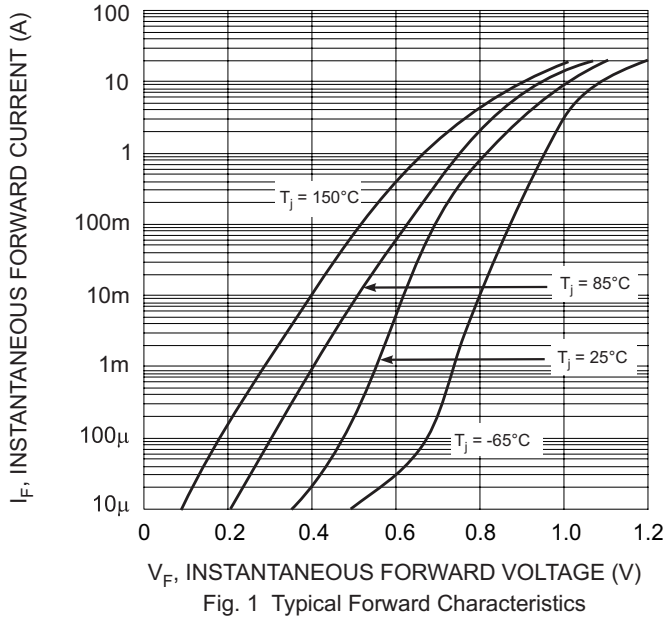
Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	R <sub>θJS</sub>	—	1.5	°C/W
Thermal Resistance Junction to Ambient Air (Note 2)	R <sub>θJA</sub>	75	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 3)	R <sub>θJA</sub>	65	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 4)	R <sub>θJA</sub>	45	—	°C/W

- Notes:
1. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see *EU Directive Annex Notes 5 and 7*.
  2. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
  3. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
  4. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 9.4 mm x 7.2 mm. Anode pad dimensions 2.7 mm x 1.6 mm.

**Electrical Characteristics** @  $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	400	—	—	V	$I_R = 10\mu\text{A}$
Forward Voltage	$V_F$	—	0.92	1.15	V	$I_F = 5\text{A}$ , $T_S = 25^\circ\text{C}$
Reverse Leakage Current (Note 5)	$I_R$	—	0.02 9	10 250	$\mu\text{A}$	$T_S = 25^\circ\text{C}$ , $V_R = 400\text{V}$ $T_S = 125^\circ\text{C}$ , $V_R = 400\text{V}$
Reverse Recovery Time	$t_{rr}$	—	3.3	—	$\mu\text{s}$	$I_F = 0.5\text{A}$ , $I_R = 1.0\text{A}$ , $I_{rr} = 0.25\text{A}$

- Notes:
- FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
  - Polymide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
  - Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4 mm x 7.2 mm. Anode pad dimensions 2.7 mm x 1.6 mm.
  - Short duration test pulse used to minimize self-heating effect.
  - Polymide PCB, 2 oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 3.0mm.



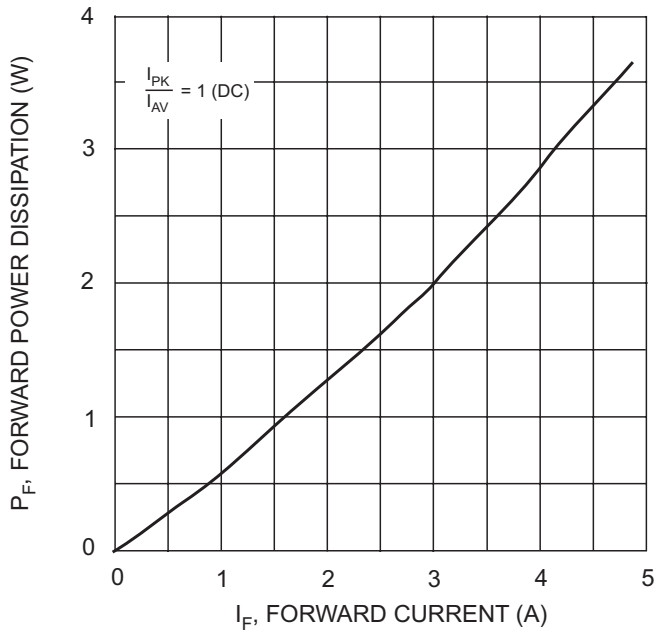


Fig. 5 Forward Power Dissipation

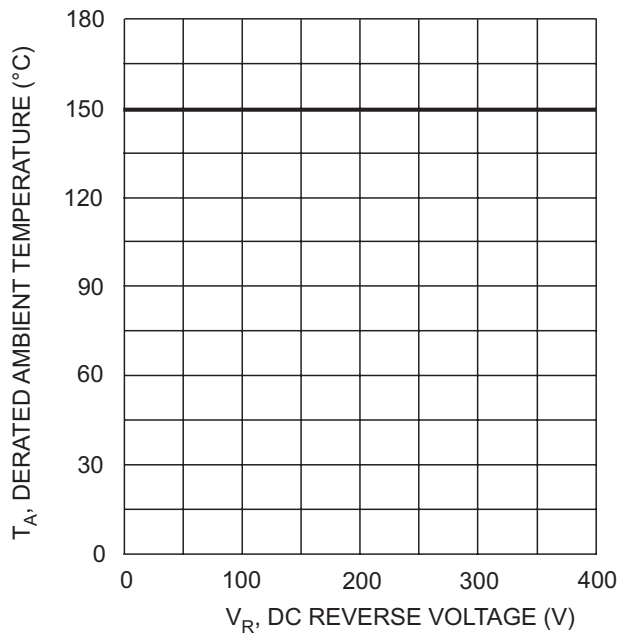


Fig. 6 Operating Temperature Derating

**Ordering Information** (Note 7)

Device	Packaging	Shipping
PDR5G-13	PowerDI™5	5000/Tape & Reel

Notes: 7. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

**Marking Information**



R5G = Product type marking code  
 Ⓜ = Manufacturers' code marking  
 YYWW = Date code marking  
 YY = Last two digits of year ex: 05 for 2005  
 WW = Week code 01 to 52  
 K = Factory Designator